



In re Application of: FUMIAKI AGA
Application No. 09/838,161
Filed: April 20, 2001
For: EPOXY RESIN ENCAPSULATING SEMICONDUCTOR CHIP AND MARKED RESIN ENCAPSULATED SEMICONDUCTOR CHIP

COMMISSIONER FOR PATENTS
Washington, D.C. 20231

Sir:

Transmitted herewith is a response to an office action in the subject application.

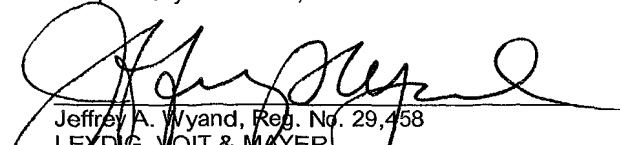
- ☐ Applicants claim small entity status of this application under 37 CFR 1.27.
- ☒ Petition for Extension of Time
- ☒ Applicants petition for a one-month extension of time under 37 CFR 1.136, the fee for which is \$110.00 (enclosed).
- ☐ Applicants believe that no petition for an extension of time is necessary. However, to the extent that such petition is deemed necessary, Applicants hereby petition for a sufficient extension of time to render the present submission timely. Please charge Deposit Account No. 12-1216 for the appropriate petition fee.
- ☒ No additional claim fee is required.
- ☒ Other: Partial English translation of Japanese Patent Laid-Open No. 10-204155.

The claim fee has been calculated as shown below:

| | | | | | SMALL ENTITY | | OTHER THAN A SMALL ENTITY | | |
|--------------------------|--------------------------------------|---|-------|---|----------------------------|--------|---------------------------|--------|------------------------|
| | | CLAIMS REMAINING AFTER AMENDMENT | | HIGHEST NUMBER PREVIOUSLY PAID FOR | EXTRA CLAIMS PRESENT | RATE | ADDIT. CLAIM FEE | RATE | ADDIT. CLAIM FEE |
| TOTAL | | | MINUS | | = | x 9= | \$ | x 18= | \$ |
| INDEPENDENT | | | MINUS | | = | x 42= | \$ | x 84= | \$ |
| <input type="checkbox"/> | FIRST PRESENTATION OF MULTIPLE CLAIM | | | | | + 140= | \$ | + 280= | \$ |
| | | | | | | TOTAL | \$ | TOTAL | \$ |

- ☒ Please charge my Deposit Account No. 12-1216 in the amount of \$110.00. A duplicate copy of this sheet is attached.
- ☐ A check in the amount of \$ is attached.
- ☒ The Commissioner is hereby authorized to charge any deficiencies in the following fees associated with this communication or credit any overpayment to Deposit Account No. 12-1216. A duplicate copy of this sheet is attached.
- ☒ Any filing fees under 37 CFR 1.16 for the presentation of extra claims.
- ☒ Any patent application processing fees under 37 CFR 1.17.

Respectfully submitted,


Jeffrey A. Wyand, Reg. No. 29,458
LEYDIS, VOIT & MAYER
700 Thirteenth Street, N.W., Suite 300
Washington, DC 20005-3960
(202) 737-6770 (telephone)
(202) 737-6776 (facsimile)

Date: October 3, 2002
JAW:ves

RECEIVED
OCT -4 2002
TECHNOLOGY CENTER 2800



#9
Amold
C
10/11/02
are

PATENT
Attorney Docket No. 401171/Fukami

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

FUMIAKI AGA

Application No. 09/838,161

Art Unit: 2827

Filed: April 20, 2001

Examiner: L. Cruz

For: EPOXY RESIN ENCAPSULATING
SEMICONDUCTOR CHIP AND
MARKED RESIN ENCAPSULATED
SEMICONDUCTOR CHIP

RECEIVED
OCT - 4 2002
TECHNOLOGY CENTER 2800

RESPONSE TO OFFICE ACTION

Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

In response to the Office Action dated June 7, 2002, please enter the following amendments and consider the following remarks.

AMENDMENTS

IN THE CLAIMS:

Cancel claims 1, 5, and 7 and replace the indicated claims with:

3. (Twice Amended) The semiconductor device according to claim 6, wherein a color difference between color of a laser mark on a surface of said package and color of the surface of said package where the laser mark is not present, as measured by a colorimeter, has a value of at least 10.

4. (Amended) The semiconductor device according to claim 6, wherein said package includes a dye providing the color of the surface of said package.